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<table>
<thead>
<tr>
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<th>Amplifiers</th>
<th>Data Converters</th>
<th>DLP® Products</th>
<th>DSP</th>
<th>Clocks and Timers</th>
<th>Interface</th>
<th>Logic</th>
<th>Power Mgmt</th>
<th>Microcontrollers</th>
<th>RFID</th>
<th>OMAP Applications Processors</th>
<th>Wireless Connectivity</th>
</tr>
</thead>
<tbody>
<tr>
<td>Automotive and Transportation</td>
<td>Communications and Telecom</td>
<td>Computers and Peripherals</td>
<td>Consumer Electronics</td>
<td>Energy and Lighting</td>
<td>Industrial</td>
<td>Medical</td>
<td>Security</td>
<td>Space, Avionics and Defense</td>
<td>Video and Imaging</td>
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</tbody>
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